

March 2007

# FODM3062/FODM3063/FODM3082/FODM3083 4-Pin Full Pitch Mini-Flat Package Zero-Cross Triac Driver Output Optocouplers

## **Features**

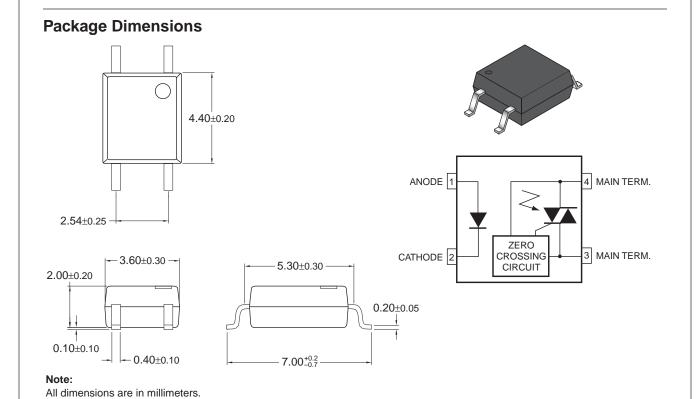
- dv/dt of 600V/µs guaranteed
- Compact 4-pin surface mount package (2.4mm maximum standoff height)
- Zero voltage crossing
- Peak blocking voltage: 600V (FODM306X) 800V (FODM308X)
- Available in tape and reel quantities of 500 and 2500.
- C-UL, UL and VDE certifications pending

# **Applications**

- Solenoid/valve controls
- Lighting controls
- Static power switches
- AC motor drives
- Temperature controls
- E.M. contactors
- AC motor starters
- Solid state relays

## **Description**

The FODM306X and FODM308X series consist of an infrared emitting diode optically coupled to a monolithic silicon detector performing the function of a zero voltage crossing bilateral triac driver, and is housed in a compact 4-pin mini-flat package. The lead pitch is 2.54mm. They are designed for use with a triac in the interface of logic systems to equipment powered from 115/240 VAC lines, such as solid state relays, industrial controls, motors, solenoids and consumer appliances.



# **Absolute Maximum Ratings** ( $T_A = 25$ °C unless otherwise specified)

Symbol	Paramete	Rating	Units	
TOTAL PACKAG	GE .		•	
T <sub>STG</sub>	Storage Temperature	-55 to +150	°C	
T <sub>OPR</sub>	Operating Temperature		-40 to +100	°C
EMITTER				
I <sub>F (avg)</sub>	Continuous Forward Current	Continuous Forward Current		
I <sub>F (pk)</sub>	Peak Forward Current (1µs pulse, 300pp	1	А	
V <sub>R</sub>	Reverse Input Voltage	6	V	
P <sub>D</sub>	Power Dissipation (No derating required	100	mW	
DETECTOR			•	
I <sub>T(RMS)</sub>	On-State RMS Current	70	mA (RMS)	
V <sub>DRM</sub>	Off-State Output Terminal Voltage FODM3062/FODM3063		600	V
		FODM3082/FODM3083	800	
P <sub>D</sub>	Power Dissipation (No derating required	300	mW	

# **Electrical Characteristics** (T<sub>A</sub> = 25°C)

## **Individual Component Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Units
EMITTER			•			
V <sub>F</sub>	Input Forward Voltage	I <sub>F</sub> = 30mA			1.5	V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> = 6V			100	μΑ
DETECTO	PR			•		
I <sub>DRM1</sub>	Peak Blocking Current, Either Direction	Rated $V_{DRM}$ , $I_F = 0^{(1)}$			500	nA
dV/dt	Critical Rate of Rise of Off-State Voltage	I <sub>F</sub> = 0 (Figure 1) <sup>(2)</sup>	600			V/µs

### **Transfer Characteristics**

Symbol	DC Characteristics	Test Conditions	Device	Min.	Тур.*	Max.	Units
I <sub>FT</sub>	LED Trigger Current	Main Terminal	FODM3062			10	mA
		Voltage = 3V <sup>(3)</sup>	FODM3082				
			FODM3063			5	
			FODM3083				
I <sub>H</sub>	Holding Current, Either Direction		All		300		μA
V <sub>TM</sub>	Peak On-State Voltage, Either Direction	I <sub>F</sub> = Rated I <sub>FT</sub> , I <sub>TM</sub> = 100mA peak	All			3	V

## **Zero Crossing Characteristics**

Symbol	Characteristics	Test Conditions	Device	Min.	Тур.*	Max.	Units
V <sub>IH</sub>	Inhibit Voltage, MT1-MT2 Voltage above which device will not trigger	I <sub>F</sub> = Rated I <sub>FT</sub>	All			20	V
IDRM2	Leakage in Inhibit State	I <sub>F</sub> = Rated I <sub>FT</sub> , Rated VDRM, Off-State	All			500	μΑ

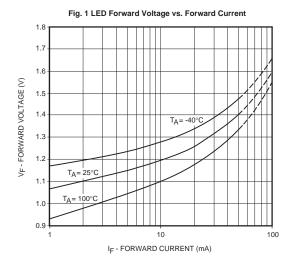
## **Isolation Characteristics**

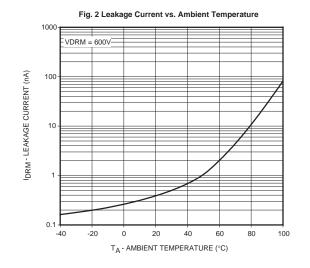
Characteristics	Test Conditions	Symbol	Device	Min.	Тур.*	Max.	Units
Steady State Isolation Voltage <sup>(4)</sup>	(1 Minute) R.H. = 40% to 60%	V <sub>ISO</sub>	All	3750			VRMS

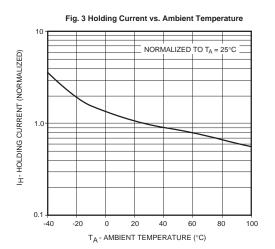
#### Notes:

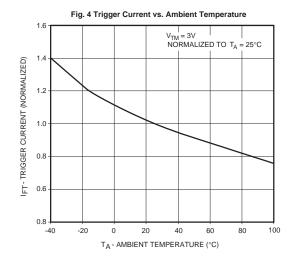
- \* All typicals at 25°C.
- 1. Test voltage must be applied within dv/dt rating.
- 2. This is static dv/dt. See Figure 1 for test circuit. Commutating dv/dt is function of the load-driving thyristor(s) only.
- 3. All devices are guaranteed to trigger at an  $I_F$  value less than or equal to max  $I_{FT}$ . Therefore, recommended operating  $I_F$  lies between max  $I_{FT}$  (10mA for FODM3062/82, 5mA for FODM3063/83) and absolute max  $I_F$  (60 mA).
- 4. Steady state isolation voltage, V<sub>ISO</sub>, is an internal device dielectric breakdown rating. For this test, pins 1 & 2 are common, and pins 3 & 4 are common.

# **Typical Performance Curves**



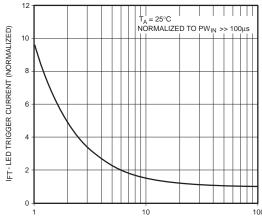






# **Typical Performance Curves**

Fig. 5 LED Current Required to Trigger vs. LED Pulse Width



 $PW_{\mbox{IN}}$ - LED TRIGGER PULSE WIDTH (°C)

Fig. 6 Off-State Output Terminal Voltage vs. Ambient Temperature

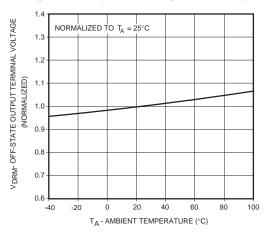
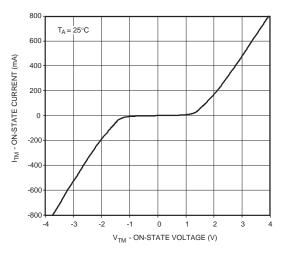


Fig. 7 On-State Characteristics



## **Typical Performance Curves**

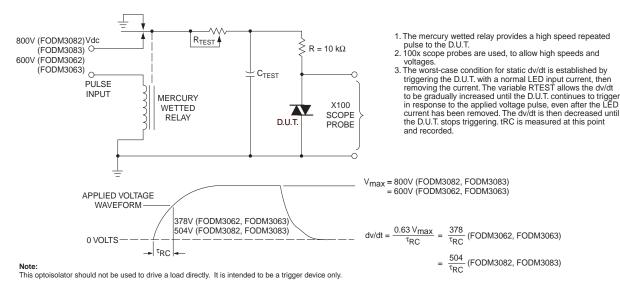
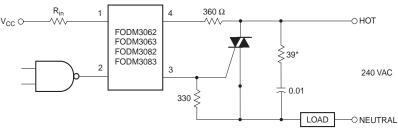


Figure 8. Static dv/dt Test Circuit



\*For highly inductive loads (power factor < 0.5), change this value to 360 ohms

Figure 9. Hot-Line Switching Application Circuit

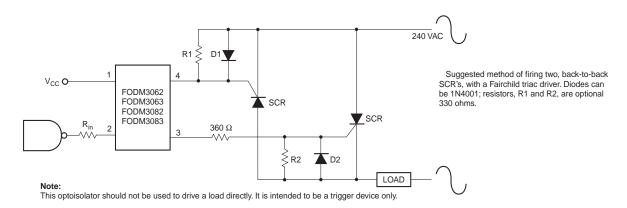


Figure 10. Inverse-Parallel SCR Driver Circuit (240VAC)

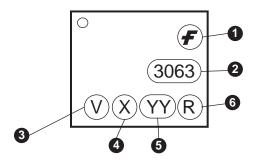
Typical circuit for use when hot line switching of 240VAC is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or

 $R_{in}$  is calculated so that  $I_F$  is equal to the rated  $I_{FT}$  of the part, 5mA for the FODM3063/83 and 10mA for the FODM3062/82. The  $39\Omega$  resistor and  $0.01\mu F$  capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load used.

# **Ordering Information**

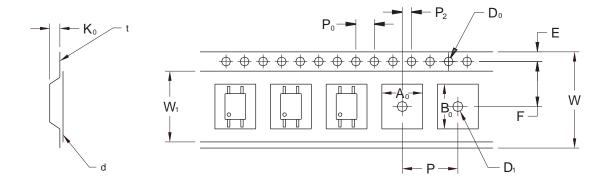
Option	Description
No option	Bulk (100 units/tube)
V	VDE Approved
R1	Tape and Reel (500 units)
R2	Tape and Reel (2500 units)
R1V	Tape and Reel (500 units) and VDE Approved
R2V	Tape and Reel (2500 units) and VDE Approved

# **Marking Information**



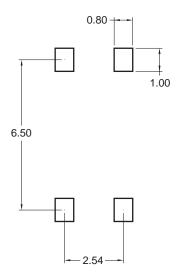
Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	One digit year code			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			

# **Tape and Reel Information**



			2.54 Pitch
Description		Symbol	Dimensions
Tape Width		W	12.00±0.3
Tape Thickness		t	0.30±0.05
Sprocket Hole Pitch		P <sub>0</sub>	4.00±0.1
Sprocket Hole Dia.		D <sub>0</sub>	1.50±0.1
Sprocket Hole Location		E	1.75±0.1
Pocket Location		F	5.50±0.1
		P <sub>2</sub>	2.00±0.1
Pocket Pitch		Р	8.00±0.1
Pocket Dimension		A <sub>0</sub>	3.90±0.1
		B <sub>0</sub>	7.45±0.1
		K <sub>0</sub>	2.45±0.1
Pocket Hole Dia.		D <sub>1</sub>	1.50±0.1
Cover Tape Width		W <sub>1</sub>	9.30±0.1
Cover Tape Thickness		d	0.062±0.02
Max. Component Rotation or Tilt			20° max
Devices Per Reel R1			500
	R2		2500
Reel Diameter	R1		178 mm (7")
	R2		330 mm (13")

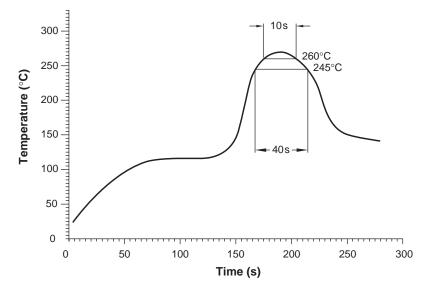
# **Footprint Drawing for PCB Layout**



**Note:** All dimensions are in mm.

# **Recommended Infrared Relow Soldering Profile**

- Peak reflow temperature: 260°C (package surface temperature)
- Time of temperature higher than 245°C: 40 seconds or less
- Number of reflows: 3







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Rev. 124